



JOR214 Series

Photo Relay

Description

The JOR214 Photo relay consist of a photo MOSFET、Photovoltage generator、infrared LED.

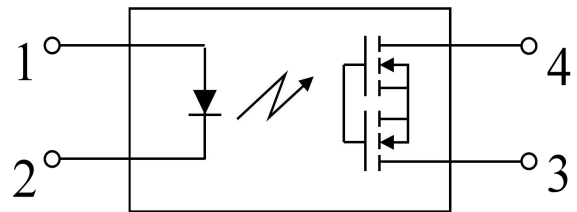
Features

- Normally opened (SPST)
- Control 400V AC or DC voltage
- Switch 120mA load
- Controls low-level analog signal
- High sensitivity, low conductivity resistance
- Low-level off state leakage current
- High isolation voltage 3750V_{rms}
- Lead free, meet RoHS standards

Applications

- Communications products (Personal computers, Laptops)
- Modem/Sensor
- Mobile phones/Security equipment
- Measuring and Testing equipment
- Plant automation equipment
- High-speed inspection machines

SCHEMATIC

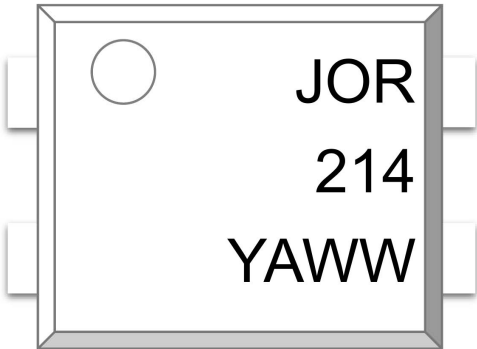



PIN DEFINITION

- | | |
|------------|----------|
| 1. ANODE | 3. DRAIN |
| 2. CATHODE | 4. DRAIN |

PACKAGE OUTLINE



ORDERING AND MARKING INFORMATION	
MARKING INFORMATION	
 <p style="text-align: center;"> JOR 214 YAWW </p>	<p>JOR : Company Abbr. 214 : Part Number YAWW : LOT NO.</p>
ORDERING INFORMATION	LABEL INFORMATION
<p style="text-align: center;">JOR214(Z)-GV</p> <p>JOC– Company Abbr 214 – Part Number Z – Tape and Reel Option (T1/T2) G – Green V – VDE</p>	 <p> J 捷捷微电 (深圳) 有限公司 JIEJIE MICROELECTRONICS (Shenzhen) Co Ltd Part No.:XXXXXXXXX Bin Code: X Lot No.: XXXXXXXXXXXX Date Code: XXXX QTY: XXX PCS </p>

Insulation and Safety related specifications

Item	Symbol	Value	Unit	Note
Creepage Distance	L	5.0	mm	Measured from input terminals to output terminals, shortest distance path along body.
Clearance Distance	L	5.0	mm	Measured from input terminals to output terminals, shortest distance through air.
Insulation Thickness	DTI	0.3	mm	Insulation thickness between emitter and detector.
Peak Isolation Voltage	V_{IORM}	600	V_{peak}	DIN/EN/IEC EN60747-5-5.
Transient Isolation Voltage	V_{IOTM}	5000	V_{peak}	DIN/EN/IEC EN60747-5-5.
Isolation Voltage	V_{ISO}	3750	V_{rms}	For 1 minute.

Absolute Maximum Ratings ($T_A=25^{\circ}C$)

	Parameter	Symbol	Rating	Unit
Input	LED Forward Current	I_F	50	mA
	LED Reverse Voltage	V_R	5	V
	Peak Forward Current	I_{FP}	1	A
	Power Dissipation	P_{in}	75	mW
Output	Load Voltage (Peak AC)	V_L	400	V
	Continuous Load Current	I_L	0.12	A
	Peak Load Current	I_{peak}	0.3	A
	Power Dissipation	P_{out}	300	mW
	Isolation Voltage	V_{ISO}	3750	V_{rms}
	Operating Temperature	T_{opr}	-40~+85	$^{\circ}C$
	Storage Temperature	T_{stg}	-40~+100	$^{\circ}C$
	Soldering Temperature	T_{sol}	260	$^{\circ}C$

Electro-optical Characteristics ($T_A=25^\circ\text{C}$)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	LED Operate Current	I_{Fon}	$I_L = 0.12\text{A}$	-	0.29	3	mA
	LED Turn Off Current	I_{Foff}	$I_L = 0.12\text{A}$	0.05	0.28	-	mA
	LED Dropout Voltage	V_F	$I_F=5\text{mA}$	1	1.3	1.4	V
Output	On Resistance	R_{on}	$I_F = 5\text{mA}$, $I_L = 0.12\text{A}$ Within 1s on time	-	16	20	Ω
	Off State Leakage Current	I_{Leak}	$I_F = 0\text{mA}$ $V_L = 400\text{V}$	-	-	1000	nA
Transfer Characteristics	Turn On Time	T_{on}	$I_F = 5\text{mA}$ $I_L = 0.12\text{A}$	-	80	1000	us
	Turn Off Time	T_{off}	$I_F = 5\text{mA}$ $I_L = 0.12\text{A}$	-	400	1000	us
	I/O Capacitance	C_{ISO}	$f = 1\text{MHz}$ $V_B = 0\text{V}$	-	0.8	1.5	pF
	Initial I/O Isolation Resistance	R_{ISO}	500 V DC	1000	-	-	M Ω

Typical Electro-Optical Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

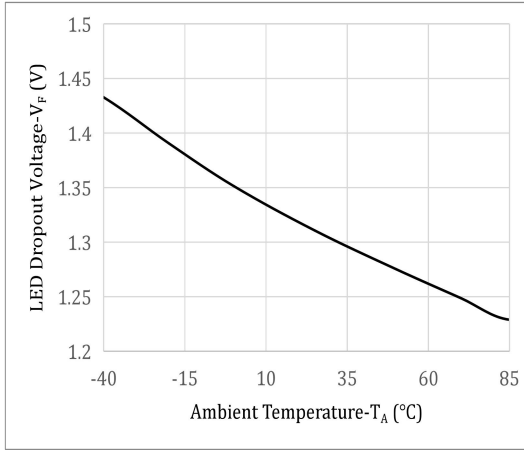


Fig.2 Output Current vs. Output Voltage

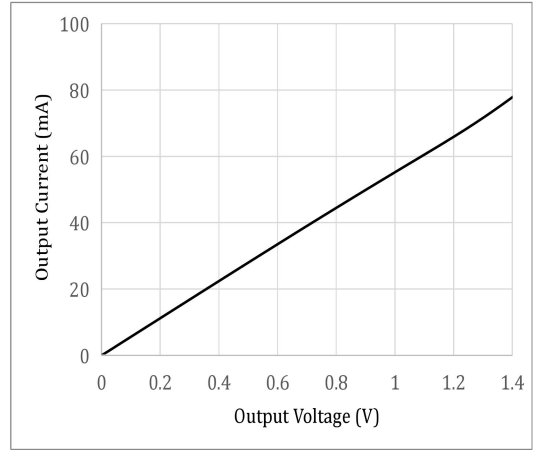


Fig.3 On Resistance vs. Ambient Temperature

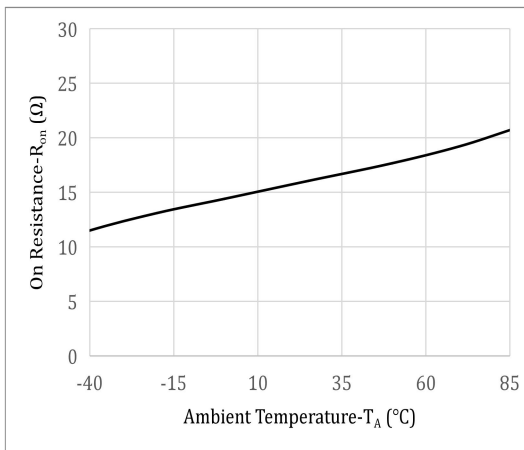


Fig.4 Load Current vs. Ambient Temperature

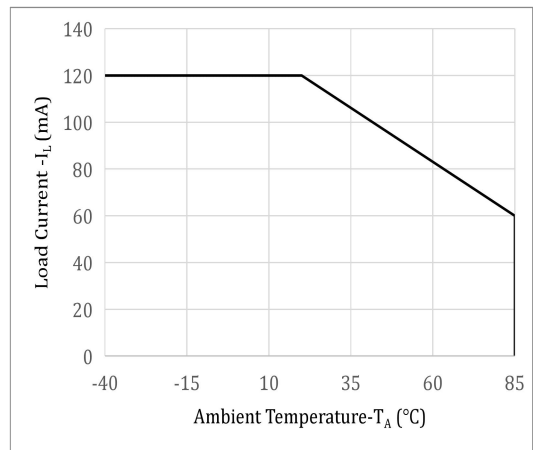


Fig.5 LED Operate Current vs. Ambient Temperature

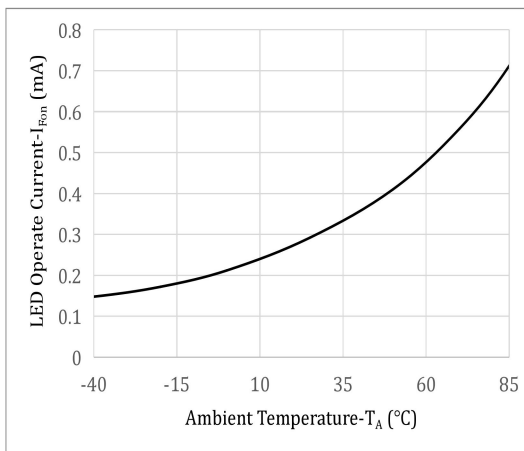


Fig.6 LED Turn Off Current vs. Ambient Temperature

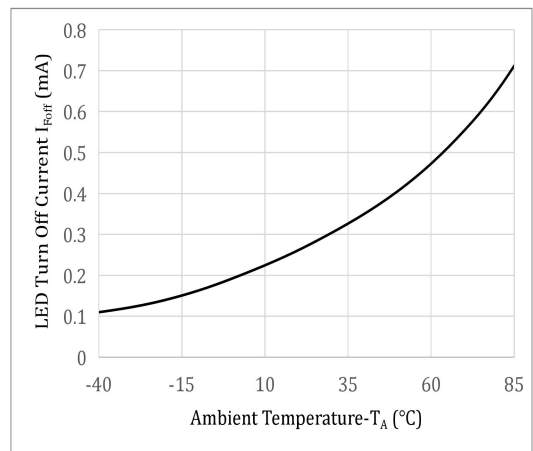


Fig.7 Turn On Time vs. Ambient Temperature

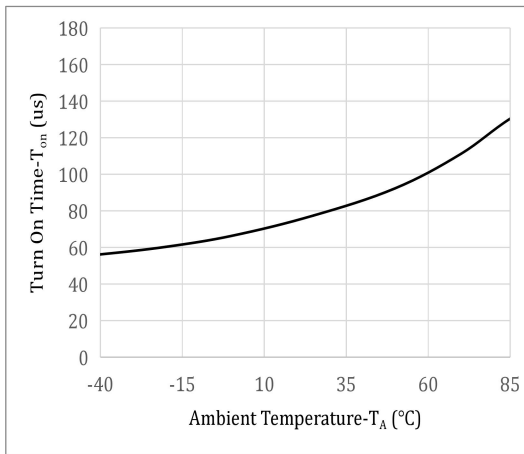


Fig.8 Turn Off Time vs. Ambient Temperature

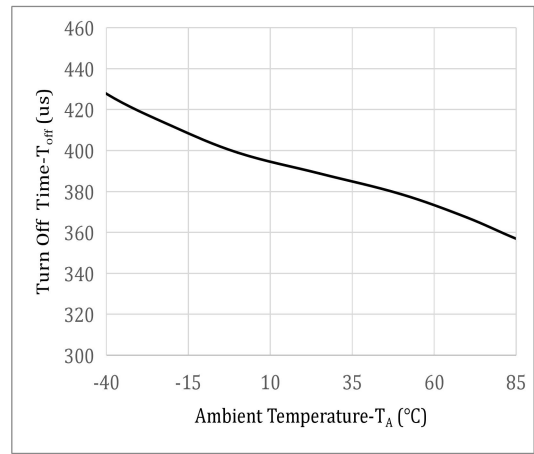


Fig.9 Turn On Time vs. LED Forward Current

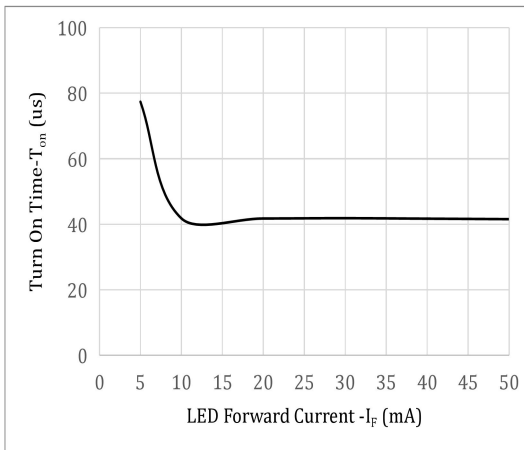
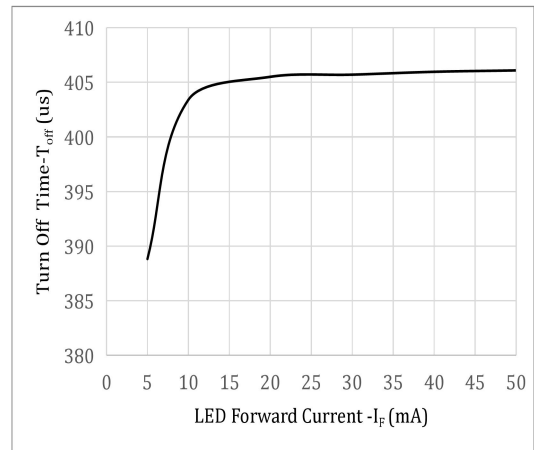
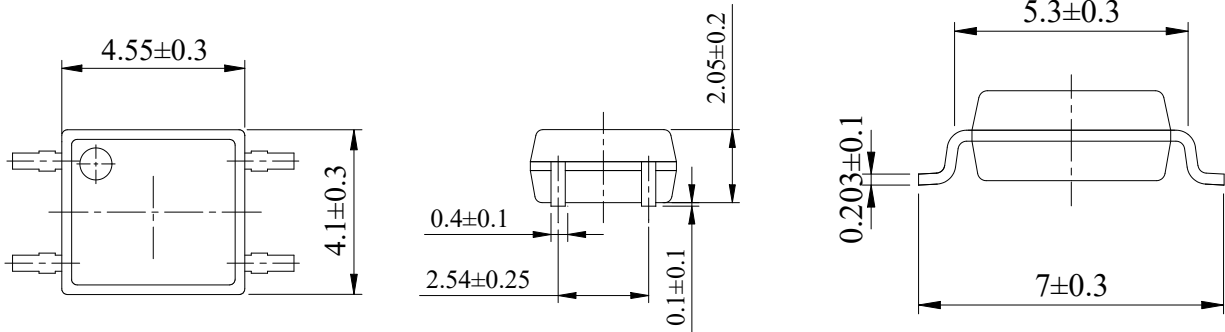


Fig.10 Turn Off Time vs. LED Forward Current



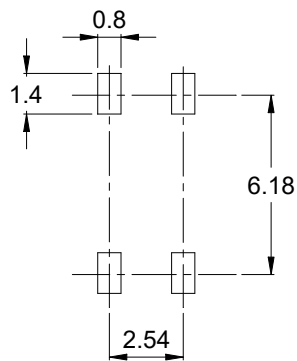
Outline Dimensions

SOP4



Unit: mm

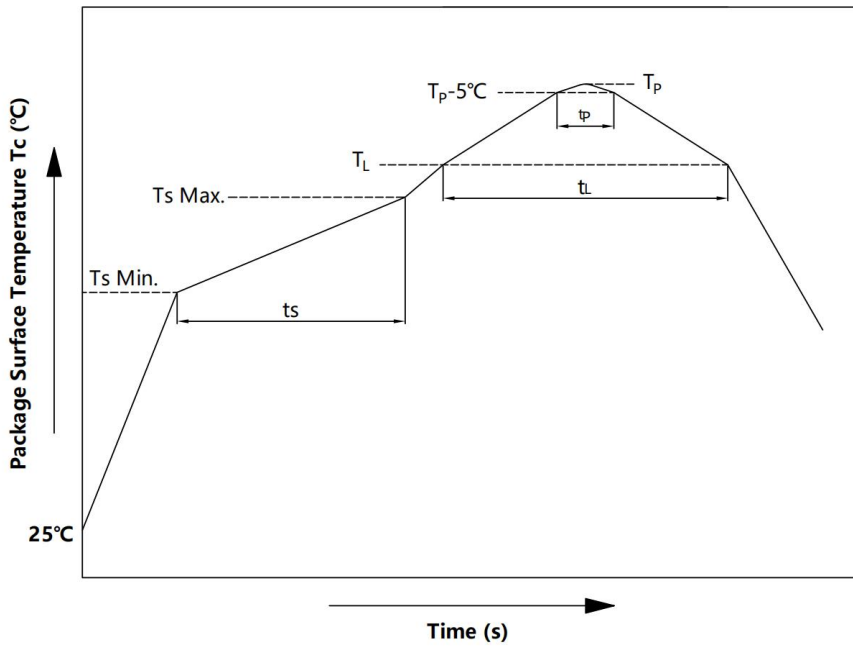
Recommended Pad Layout



Unit: mm

Note: The picture above is the front view of the product.

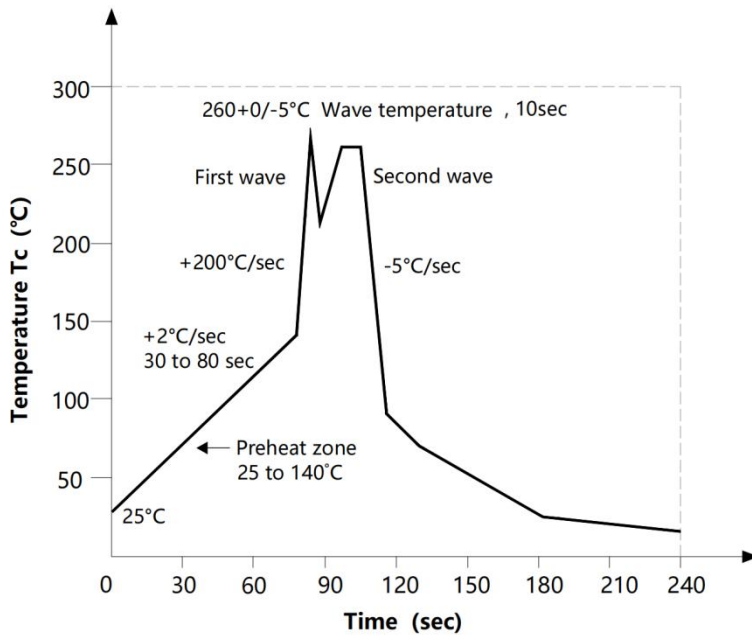
Solder Reflow Profile



Item	Symbol	Min.	Max.	Unit
Preheat Temperature	T_s	150	200	$^\circ\text{C}$
Preheat Time	t_s	60	120	s
Ramp-Up Rate (T_L to T_P)	-	-	3	$^\circ\text{C}/\text{s}$
Liquidus Temperature	T_L	217		$^\circ\text{C}$
Time Above T_L	t_L	60	150	s
Peak Temperature	T_P	-	260	$^\circ\text{C}$
Time During Which T_c Is Between ($T_P - 5$) and T_P	t_p	-	30	s
Ramp-down Rate (T_P to T_L)	-	-	6	$^\circ\text{C}/\text{s}$

Note: Reflow soldering is recommended at the temperatures and times shown, no more than three times.

Wave Soldering Profile



Soldering with hand soldering iron

- A. Hand soldering iron is only used for product rework or sample testing;
- B. Manual soldering method Temperature: 360°C ± 5°C, within 3s.

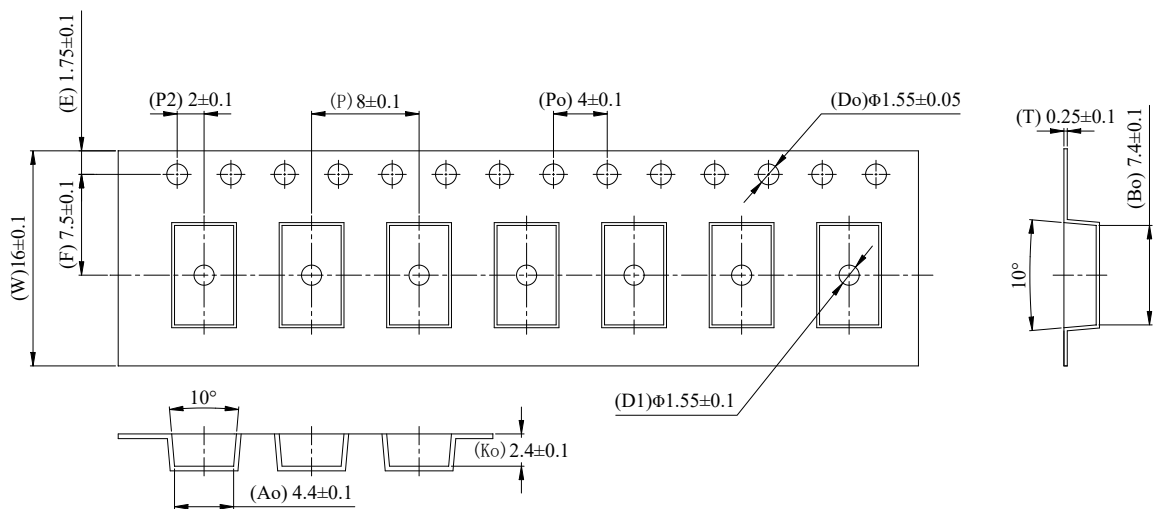
Packing

Summary table

Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP4	Reel (φ330mm Blue)	3000 pcs /reel	2 reels /box	10 boxes /ctn	380*380mm	340*60*340 mm	620*360*365cm	Leave at least 200mm of blank space at both ends

Tape & Reel

- 1) Qty/reel: 3000 pcs.
- 2) Qty/ctn: 60000 pcs.
- 3) Inner packing: 2 reels/box.
- 4) Schematic:



Unit: mm